



# Product Change Notification

**Change Notification #:** 119634-00

**Change Title:** Intel® Server System D50DNP2MFALAC  
Acceleration Module,  
PCN 119634-00, Product Design,  
Cable Replacement

**Date of Publication:** July 24, 2023

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material*</b>	August 01, 2023
---	-----------------

\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

The Intel® Server Systems D50DNP2MFALAC Acceleration Module SKU listed in the products affected table will have the following change:

- The I2C signal cable M44104-001 connecting the power distribution board to the mother board will be replaced with the new model M44104-002. The new cable is made with the increased terminals crimping force, improving connection reliability.

## Customer Impact of Change and Recommended Action:

Intel does not expect any other impact to customers from these changes but encourages customers to understand the change and determine the impact on their applications. For that reason, Intel recommends that the customer perform a standard level of evaluation.

**Products Affected/Intel Ordering Codes:**

<b>Marketing Name</b>	<b>Product Code</b>	<b>MM#</b>	<b>Pre Change TA</b>	<b>Pre Change SA</b>	<b>Pre Change PBA</b>	<b>Post Change TA</b>	<b>Post Change SA</b>	<b>Post Change PBA</b>
Intel® Server System D50DNP2MFALAC Acceleration Module	D50DNP2MFALAC	99ARWX	M65146-002	N12586-002	M80131-002	M65146-003	N12586-003	M80131-003

**PCN Revision History:**

**Date of Revision:**

July 24, 2023

**Revision Number:**

00

**Reason:**

Originally Published PCN



# Product Change Notification

## 119634-00

### Notices & Disclaimers

No license (express or implied, by estoppel or otherwise) to any intellectual property rights is granted by this document.

Intel disclaims all express and implied warranties, including without limitation, the implied warranties of merchantability, fitness for a particular purpose, and non-infringement, as well as any warranty arising from course of performance, course of dealing, or usage in trade, except as provided in a separate written agreement.

You may not use or facilitate the use of this document in connection with any infringement or other legal analysis concerning Intel products described herein. You agree to grant Intel a non-exclusive, royalty-free license to any patent claim thereafter drafted which includes the subject matter disclosed herein.

The products described may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Statements in this document that refer to future plans or expectations are forward-looking statements. These statements are based on current expectations and involve many risks and uncertainties that could cause actual results to differ materially from those expressed or implied in such statements. For more information on the factors that could cause actual results to differ materially, see our most recent earnings release and SEC filings at [www.intc.com](http://www.intc.com).

Customer is responsible for safety of the overall system, including compliance with applicable safety-related requirements or standards.

Intel technologies may require enabled hardware, software or service activation.

No product or component can be absolutely secure.

Your costs and results may vary.

©Intel Corporation. Intel, the Intel logo, and other Intel marks are trademarks of Intel Corporation or its subsidiaries. Other names and brands may be claimed as the property of others.

No response from customers will be deemed an acceptance of the change, and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below.

**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

**Asia Pacific/PRC Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

**Europe Email:** [eccb@intel.com](mailto:eccb@intel.com)

**Japan Email:** [jccb.ijkk@intel.com](mailto:jccb.ijkk@intel.com)